

SINGLE PHASE GLASS PSSIVATED BRIDGE RECTIFIER

KBJ401G THRU KBJ407G

VOLTAGE RANGE CURRENT 50 to 1000 Volts 4.0 Ampere

FEATURES

 Plastic package has UL flammability Classification 94V – 0

Glass passivated chip junction

• High case dielectric strength of 1500 V_{RMS}

High surge current capability

• High temperature soldering guaranteed: 260 °C /10 seconds, 0.375" (9.5mm) lead length

MECHANICAL DATA

Case: Molded plastic body

• Terminals: Plated leads solderable per MIL-STD-750

Method 2026

Mounting position: any (Note 3)
Mounting Torque: 6 in-lbs max.
Weight: 0.15 ounce, 4.0 gram

KBJ Min 25.20 24.80 14.70 4.00 Nominal D 17.20 17.80 Е 0.90 1.10 G 7.30 7.70 Н 3.10ø 3.40ø J 3.30 3.70 1.50 1.90 9.30 9.70 М 2.50 2.90 N 3.40 3.90 Р 4.40 4.80 0.60 All Dimensions in mm **KBJ**

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25^oC ambient temperature unless otherwise specified

• Single Phase, half wave, 60Hz, resistive or inductive load

For capacitive load derate current by 20%

	SYMBOLS	KBJ 401G	KBJ 402G	KBJ 403G	KBJ 404G	KBJ 405G	KBJ 406G	KBJ 407G	UNIT
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	Volts
Maximum Average Forward @ $T_C = 100^{\circ}$ C (Note 1) Rectified Current, @ $T_A = 40^{\circ}$ C (Note 2)	I _(AV)	4.0 3.0							Amps
Peak Forward Surge Current 8.3mS single half sine wave superimposed on rated load (JEDEC method)	I _{FSM}	150							Amps
Rating for Fusing (t<8.3mS)	I^2t	93							A^2s
Maximum Instantaneous Forward Voltage drop per Bridge element 2.0A	V_{F}	1.0							Volts
Maximum DC Reverse Current at Rated $T_A = 25$ °C	ī	5.0							μΑ
DC Blocking Voltage per element $T_A = 125$ °C	I_R	500							
Typical Junction Capacitance, per leg (Measured at 1.0MHz and applied reverse voltage of 4.0V)	C_{J}	100 45					pF		
Typical Thermal Resistance (Note 1)	$R_{\theta JA}$	22							^o C/W
Operating Junction Temperature Range	T_{J}	(-55 to +150)							°С
Storage Temperature Range	T_{STG}	(-55 to +150)							^o C

Notes:

- 1. Unit mounted on 1.6" x 1.6" x 0.06" (4cm x 4cm x 0.15cm) AL plate
- 2. Unit mounted on PCB with 0.5" x 0.5" (12mm x 12mm) copper pads and 0.375 (9.5mm) lead length
- 3. Recommended mounting position is to bolt down on heatsink using #6 screw and silicon thermal compound for maximum heat transfer

RATINGS AND CHARACTERISTIC CURVES KBJ401G THRU KBJ407G











